

# Global Leading Manufacturer & High Thermal Solutions of Metal Laminate

**High Thermal Conductivity IMS/MCCL Datasheet** 

# 江西博秘电子有限公司

JiangXi BOYU Electronics CO.,Ltd



#### JIANGXI BOYU 应函博称



#### ntroduction

**J**iangXi BOYU Electronics Co., Ltd, is a high-tech enterprise which integrates R&D, production, service and one-stop solutions and concentrates on providing high-quality products of Aluminum and Copper Based CCL and special metal CCL to our customers.

The company has been awarded a series of international certifications such as ISO, UL, SGS, IATF16949 and ROHS.

The company is committed to the global market and has successfully exported products to Europe, USA, Southeast Asia and other countries and regions.

The company adheres to the business strategy of "Using the most advanced technology, Training high-quality employees, Manufacturing high-quality products", striving for innovation and contributing to the development of new technology and new materials for the electronic industry.

#### 产品应用

LED backlighting

**LED** backlighting

普通照明

Regular lighting

消费类电子

**C**onsumer Electronics

电动工具

Power tools

产品特性

高导热特性

High thermal conductivity

出色的耐热性

Excellent heat resistance

符合 RoHS 要求

Meet the RoHS requirements

无卤素板材

Halogen-free

UL E333613

**U**L E333613

符合 UL 94V-0

Comply with UL 94V-0





# CU-01-B10 产品性能表

(Criterion: Typical value is based on specimen of 1.5mm CU \120\mm dielectric just for reference.)						
性能	测试方法	单位	指标值	典型值		
PROPERTIES	TEST METHOD	UNIT	INDICATOR	TYPICAL VALUES		
热性能 THERMAL PROPERTIES						
	10711 05 170	W / W				
Thermal Conductivity	ASTM D5470	W/m. K		1. 0		
热阻	ASTM D5470	°C*in²/W	_	0. 176		
Thermal Resistivity	ASTM DS470	O · III / II		0.170		
玻璃化温度 Tg	DSC	°C	_	110		
热分解温度     Td	TGA(Wt5%loss)	°C	≥360	380		
最大操作温度 MOT	UL94	°C	_	130		
热应力 Thermal Stress	Solder floating 288°C	Minute	≥15	25		
电性能 ELECTRICAL PROPERTIES						
体积电阻率 Volume Resistivity	IPC-TM-650 2.5.17	MΩ.cm	≥10°	10 <sup>8</sup>		
表面电阻率 Surface Resistivity	IPC-TM-650 2.5.17	MΩ		10 <sup>7</sup>		
介电常数 Dielectric Constant	IPC-TM-650 2.5.5.3	1MHz		4. 6		
耗损系数 Dissipation Factor	IPC-TM-650 2.5.5.3	1MHz	_	0. 02		
耐电压测试 Hi-pot test	T/CPCA4105 B. 11	AC/KV	-	5. 0		
耐电弧 Arc Resistance	IPC-TM-650 2.5.1	Sec	≥60	120		
机械性能 MECHANICAL PROPERTIES						
剥离强度 Peel Strength	IPC-TM-650 2.4.8	Lb/in	≥8	8		
吸水率 Moisture Absorption	D-24/23	- %	≤1.5	0. 15		
机构评级&阻燃性 AGENCY RATINGS&DURABILITY						

#### 高导热金属基覆铜板

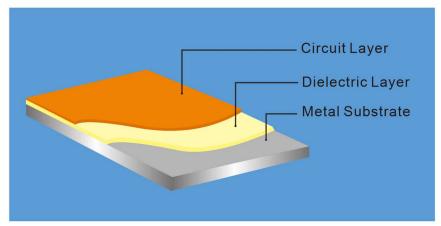
#### **High Thermal Conductivity IMS CCL**

#### 产品介绍

#### Introduction of products

高导热金属基覆铜板能够针对不同的应用领域要求、各种铜厚、绝缘层特性、不同金属背板的需求,提供符合客户要求的高性价比产品。

For different areas of application requirements, various copper thickness, insulating layer characteristics and the need of different metal backboard, we can provide cost-effective metal based copper clad laminate with high thermal conductivity that meet customers' requirements.



#### 产品规格

### **Specification of products**

Standard BOYU Material Overview						
Item	Tolerance	Type	CU-01-B10			
Dielectric Thickness	± 10 μm	Standard	100、120、180			
		Special	75			
Base Copper	± 10% μm	Standard	18、35、70、105			
		Special	140、210			
Copper Thickness	± 0.02mm	Standard	0.3-2.0			
		Special	2.8			
Lamiante Size	± 2mm	Standard	460X610、510X610、533X610、500X600			
		Special	Specified (MOQ 500 KG)			
Remark:	Finish thickness=Copper Thickness +Thickness of Thermal Conductive+Base Copper					



## 江西博秘电子有限公司

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